VPX3U-ORIN-CX7-SBC



NVIDIA Orin Industrial, ConnectX-7, DP/HDMI Out, SBC

KEY FEATURES

- Embedded Ampere GPU with 2048 CUDA cores and 64 Gen3 Tensor cores
- Embedded 12-core NVIDIA Cortex ARM64 CPU, 2.2GHz
- 64 GB LPDDR5 256-bit memory with up to 205 GB/s
- ConnectX-7, provides up to 100GbE, PCIe Gen4
- Module power: configurable from 80W 120W

ADDITIONAL AGX ORIN FEATURES

- 2x Deep Learning Accelerator (DLA) v2 engines
- Vision Accelerator engine for 7-way VLIW Vision Processor v2
- Dedicated programmable audio processor
- 2x HEVC (H.265) and AVC (H.264) NVENC and NVDEC with up to 4K-UHD encode resolution
- CUDA[®] 12, OpenGL[®] 4.6, OpenGL ES 3.2, Vulkan[™] 1.0
- Flash Storage: 64 GB eMMC 5.1 with support for ECC

CONNECTIVITY / SYSTEM MANAGEMENT

- Storage: NVMe 1TB, SATA Gen2 (3 Gbps) interface
- ConnectX PCIe Switch, configurable, x8 or bifurcate down to x4 + x4, or down to x2
- Backplane Ethernet with 40/100GBASE-KR4 and 10GBASE-KR data planes; supports GPUDirect RDMA
- 1000BASE-T Ethernet
- USB 3.2 and USB 2.0, µUSB for setup/debug
- Security includes block-level hardware encryption and the use of dedicated encryption keys per user
- Switching is offloaded from the CPU and run on the ConnectX hardware with NVIDIA ASAP² technology
- On-board IPMI controller for system management
- WOLF BSP with Jetson Linux and JetPack SDK

MECHANICAL / OPEN SYSTEMS ARCHITECTURE

- High level of ruggedization:
 - □ Operating temperature: -40° to +80°C
 - □ Vibration (sine wave): 10G peak, 5 2000Hz
 □ Shock: 40G peak
- Dimensions: 160mm x 100mm x 25.4mm
- Weight (approx.): 1.5kg
- ANSI/VITA 48, 65 (VPX REDI, OpenVPX)
- SOSA[™] Aligned SBC slot profile 14.2.16

OVERVIEW

The VPX3U-ORIN-CX7-SBC module meets the needs of demanding C5ISR applications, providing a secure compute node with advanced AI and HPC processing capabilities, high data transfer rates, and the cyber security features required to ensure data is being protected. This autonomous SOSA aligned module includes an NVIDIA Jetson AGX Orin Industrial, and an NVIDIA ConnectX-7 SmartNIC.

The NVIDIA Orin's embedded Ampere GPU provides the CUDA cores and Tensor cores for data processing, deep learning inference, machine vision, audio processing and video encoding/decoding.

The NVIDIA ConnectX-7 SmartNIC provides secure, highspeed network data transfer and a configurable PCIe switch. ConnectX-7 meets the high data transfer and security requirements for C5ISR tasks. It also provides support for RDMA over Converged Ethernet (RoCE) and support for NVIDIA GPUDirect, enabling the fastest method to transfer data across a network to the GPU.

Unlocking the best performance requires the best cooling capability. WOLF's advanced cooling technology is designed to move heat using a low weight, high efficiency path from the hot chips to the wedgelocks.



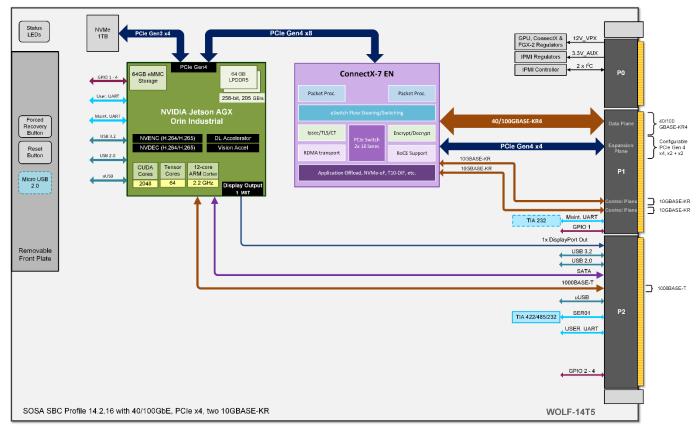


VIDIA

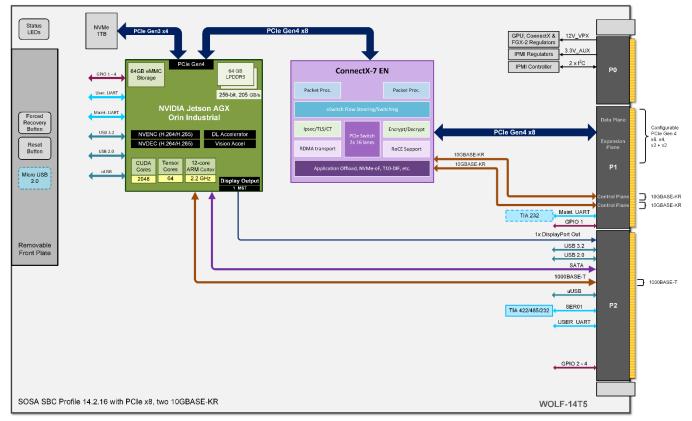
VPX3U-ORIN-CX7-SBC



The following model provides 40/100GBASE-KR4, one 10GBASE-KR, one 1000BASE-T, and PCIe Gen4 x4 (configurable).



The following model provides two 10GBASE-KR, one 1000BASE-T and PCIe Gen4 x8 (configurable).



This information is subject to change

WOLF-14T5

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NVIDIA JETSON AGX ORIN WITH AMPERE GPU AND 12-CORE ARM CPU

Jetson AGX Orin features an embedded NVIDIA Ampere GPU with 2048 CUDA Cores and 64 Gen3 Tensor Cores, two NVIDIA deep learning accelerators, a vision accelerator, a twelve-core NVIDIA Cortex Arm CPU, and a video encoder and decoder. The NVIDIA CUDA-X accelerated computing stack and JetPack SDK support enables the Jetson AGX Orin to be a fully software-defined platform.

The Jetson AGX Orin delivers up to eight times the performance compared to the previous generation Jetson AGX Xavier. Orin can deliver up to 4 times more TFLOPS, eight times more AI TOPS, and higher memory bandwidth. Second generation NVIDIA Deep Learning Accelerators (NVDLA) can deliver up to 9 times more TOPS, while the second generation Vision Accelerator can also offer performance improvements. Connectivity has also been improved with more PCIe lanes and more available Ethernet interfaces at higher speeds. All of these performance improvements only require a modest power increase, with power modes from 15W to 75W.

TENSOR CORES FOR ARTIFICIAL INTELLIGENCE AND HPEC

Tensor Cores are designed to speed up the tensor / matrix computations used for deep learning neural network training and inferencing operations. NVIDIA Ampere architecture GPUs include the third-generation Tensor Core design which supports many new data types for improved performance, efficiency, and programming flexibility, including a new sparsity feature and a new Tensor Float 32 (TF32) precision mode.

NVIDIA provides CUDA-X AI and CUDA-X HPEC libraires which have been designed to work with NVIDIA Tensor Core GPUs to provide the tools needed to accelerate development of applications for AI and HPEC.

HARDWARE ACCELERATED VIDEO ENCODE / DECODE

The Ampere GPU includes the NVENC video encode (version 7.2) and NVENC decode (version 5) hardware acceleration engine. Using the Ampere GPU for video encoding provides an efficient, high quality method to achieve real time 8K and 4K encoding without burdening the system CPU. The NVIDIA Video Codec SDK provides a complete set of APIs, samples and documentation for hardware accelerated video encode and decode.

CONNECTX-7 ETHERNET 100GbE AND PCIE GEN4

Getting large amounts of data into and out of a module is an important system design consideration. The WOLF-12T0 module includes a ConnectX-7 SmartNIC, which provides a configurable PCIe Gen4 interface. It also provides up to 100GBASE-KR4 on the VPX data plane, RDMA over Converged Ethernet (RoCE) with support for NVIDIA GPUDirect RDMA, and enhanced security features such as hardware-verified secure boot, hardware-accelerated cryptography, and encrypted storage.

SOSA SLOT PROFILE SUPPORT

The Sensor Open Systems Architecture (SOSA) Consortium grew out of a U.S. Department of Defense (DoD) initiative to define open standard electronic architectures to ensure component interoperability, reduce costs, encourage innovation, and help to ensure a supply of needed products.

This module supports SOSA aligned SBC slot profiles. The default profile is:

• 14.2.16-0

WOLF also offers a module which supports the SOSA aligned Payload slot profile, VPX3U-ORIN-CX7-HPC.

VPX3U-ORIN-CX7-SBC



ORDERING CODES

The following table defines series of common order codes for the VPX3U-ORIN-CX7- SBC module. The asterisks denote characters of the part number that are defined based on common configuration options. Some common configuration options for this module are:

• Display Outputs

Default Power Threshold Conformal Coatings

- PCIe Configuration OptionsNetwork Configuration Options
- Variant Locked
- Network Security Options
- Ordering NumberDescription3U VPX Single Slot Configurations14T533-F***-***VPX3v103U VPX, Conduction Cooled, 1", NVIDIA Orin, ConnectX-7, 40/100GBASE-KR4, two
10GBASE-KR, one 1000BASE-T, PCIe Gen4 x4, 1x DP Output14T533-F***-***VPX3v103U VPX, Conduction Cooled, 1", NVIDIA Orin, ConnectX-7, two 10GBASE-KR, one
1000BASE-T, PCIe Gen4 x8, 1x HDMI Output

* Contact Sales for the latest Ordering Numbers and available options

MANUFACTURING AND QUALITY ASSURANCE

WOLF designs modules to pass the following environmental standards:

- MIL-STD-810 (United States Military Standard for Environmental Engineering Considerations and Laboratory Tests)
- MIL-HDBK-217 (Reliability Prediction of Electronic Equipment)
- RTCA DO-160 (Environmental Conditions and Test Procedures for Airborne Equipment) on request

WOLF complies with the following management systems:

- AS9100D: Quality Management System Requirements for Aviation, Space and Defense Organizations (certified)
- ISO 9001:2015: Quality management systems (certified)
- AS5553: Counterfeit Electronic Parts; Avoidance, Detection, Mitigation, and Disposition (compliant)
- NIST SP 800-171: Protecting Controlled Unclassified Information in Nonfederal Systems (compliant)

Boards are manufactured to meet the following standards:

- IPC-A-610 CLASS 3 (Acceptability of Electronic Assemblies)
- IPC 6012 CLASS 3 (Qualification and Performance Specification for Rigid Printed Boards, Class 3 for High Reliability Electronic Products)
- IPC J-STD-001 (Requirements for Soldered Electrical and Electronic Assemblies)

Caveat: integrated third party modules may not meet the same standards as WOLF manufactured modules.





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Datasheet Rev.1

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